

### Description

The ZXGD3006E6Q is a 40V Gate Driver for switching IGBTs and SiC MOSFETs. It can transfer up to 10A peak source/sink current into the gate for effective charging and discharging of a large capacitive load.

The ZXGD3006E6Q can drive typically 4A into the low gate impedance of an IGBT, with just 1mA input from a controller. Also, the turn-on and turn-off switching behavior of the IGBT can be individually tailored to suit an application. In particular, by defining the switching characteristics appropriately, EMI and cross conduction can be reduced.

### **Applications**

Gate driving IGBTs and SiC MOSFETs in:

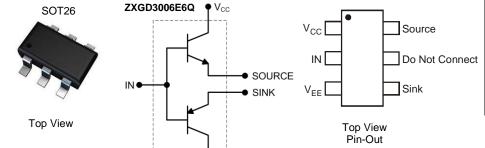
- DC-DC Converters in Electric Cars
- Automotive Active Suspension Systems
- Solar Inverters
- **Power Supplies**
- Plasma Display Panel Power Modules

#### **Features**

- High-Gain Buffer with Typically 4A Output from 1mA Input
- 40V Supply for +20V to -18V gate driving to prevent dV/dt induced false triggering
- Emitter-Follower that is Rugged to Latch-Up / Shoot-Through Issues, and Delivers <10ns Propagation Delay Time
- Optimized Pin-Out to Simplify PCB Layout and Reduce Parasitic Trace Inductances
- Near-Zero Quiescent Supply Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### **Mechanical Data**

- Case: SOT26
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (93)
- Weight: 0.018 grams (Approximate)



| Pin Name | Pin Function            |  |  |  |
|----------|-------------------------|--|--|--|
| Vcc      | Supply Voltage High     |  |  |  |
| IN       | Driver Input Pin        |  |  |  |
| $V_{EE}$ | Supply Voltage Low      |  |  |  |
| SOURCE   | Source Current Output * |  |  |  |
| SINK     | Sink Current Output *   |  |  |  |

\* Typically connect SOURCE & SINK together

## Ordering Information (Note 5)

| Ī | Product       | Compliance | Marking | Reel Size (inches) | Tape Width (mm) | Quantity per Reel |
|---|---------------|------------|---------|--------------------|-----------------|-------------------|
|   | ZXGD3006E6QTA | Automotive | 3006    | 7                  | 8               | 3,000             |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See http://www.diodes.com/quality/lead\_free/ for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green"
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



## **Marking Information**

### SOT26

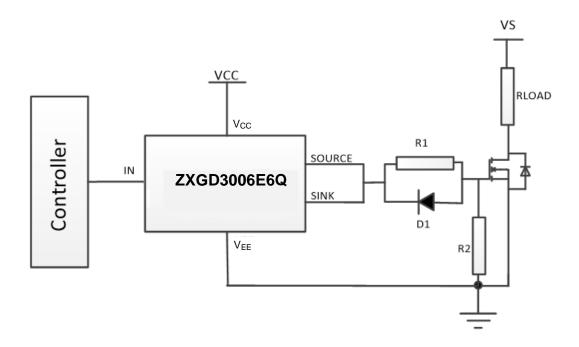


 $\begin{array}{l} 3006 = Product\ Type\ Marking\ Code \\ YM = Date\ Code\ Marking \\ Y\ or\ \overline{Y} = Year\ (ex:\ F = 2018) \\ M\ or\ \overline{M} = Month\ (ex:\ 9 = September) \end{array}$ 

Date Code Key

| = **** * * * * * * * * * * * * * * * * |      |     |     |      |      |      |      |      |      |      |      |      |      |
|--|------|-----|-----|------|------|------|------|------|------|------|------|------|------|
| Year                                   | 2018 | 2   | 019 | 2020 | 2021 | 2022 | 2022 | 2023 | 3 20 | 24 2 | 2025 | 2026 | 2027 |
| Code                                   | F    |     | G   | Н    |      | J    | K    | L    | N    | Л    | N    | 0    | Р    |
| Month                                  | 1    | Jan | Feb | Mar  | Apr  | May  | Jun  | Jul  | Aug  | Sep  | Oct  | Nov  | Dec  |
| Code                                   |      | 1   | 2   | 3    | 4    | 5    | 6    | 7    | 8    | 9    | 0    | N    | D    |

# **Typical Application Circuit**



R1, D1 combination can be used for variable turn on and turn off times.



## Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                  | Symbol                     | Value | Unit |
|---|----------------------------|-------|------|
| Supply Voltage, with Respect to V <sub>EE</sub> | V <sub>CC</sub>            | 40    | V    |
| Input Voltage, with Respect to V <sub>EE</sub>  | V <sub>IN</sub>            | 40    | V    |
| Output Difference Voltage (Source – Sink)       | $\Delta V_{(source-sink)}$ | ±7    | V    |
| Peak Pulsed Output Current (Source – Sink)      | Іом                        | ±10   | Α    |
| Peak Pulsed Input Current                       | I <sub>IN</sub>            | ±100  | mA   |

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic  | Symbol                            | Value       | Unit  |  |
|---|-----------------------------------|-------------|-------|--|
| Power Dissipation (Notes 6 & 7)                       | Б                                 | 1.1         | W     |  |
| Linear Derating Factor                                | P <sub>D</sub>                    | 8.8         | mW/°C |  |
| Thermal Resistance, Junction to Ambient (Notes 6 & 7) | R <sub>0JA</sub>                  | 113         | °C/W  |  |
| Thermal Resistance, Junction to Lead (Note 8)         | R <sub>0</sub> JL                 | 105         | C/VV  |  |
| Operating and Storage Temperature Range               | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C    |  |

## ESD Ratings (Note 9)

| Characteristic                                 | Symbol  | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model     | ESD HBM | 1,500 | V    | 1C          |
| Electrostatic Discharge – Charged Device Model | ESD CDM | 1,000 | V    | IV          |

### Notes:

<sup>6.</sup> For a device mounted on 25mm x 25mm 1oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state. The heatsink is split in half with the pin 1 (V<sub>CC</sub>) and pin 3 (V<sub>EE</sub>) connected separately to each half.

<sup>7.</sup> For device with two active die running at equal power.

<sup>8.</sup> Thermal resistance from junction to solder-point at the end of each lead on pin 1 (V<sub>CC</sub>) and pin 3 (V<sub>EE</sub>).

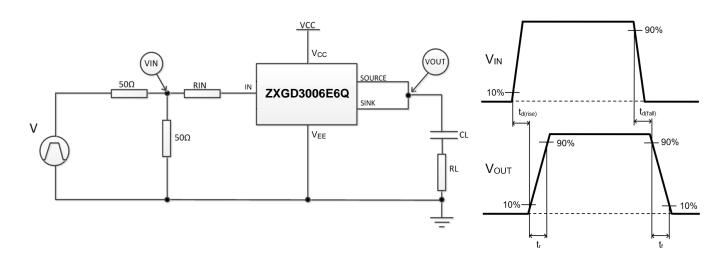
9. Refer to JEDEC specification JESD22-A114 and JESD22-C101.



# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

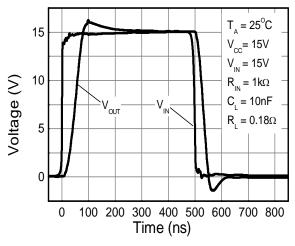
| Characteristic   | Symbol  | Min                   | Тур                              | Max                   | Unit | Test Condition  |  |
|--|---|-----------------------|----------------------------------|-----------------------|------|---|--|
| Output Voltage, High   | V <sub>OUT(hi)</sub>  | V <sub>CC</sub> - 1.0 | V <sub>CC</sub> - 0.8            | _                     | V    | $V_{IN} = V_{CC}$ $C_L = 1nF$   |  |
| Output Voltage, Low  | V <sub>OUT(low)</sub>   | _                     | V <sub>EE</sub> + 0.12           | V <sub>EE</sub> + 0.3 |      | V <sub>IN</sub> = V <sub>EE</sub>   |  |
| Supply Breakdown Voltage   | BV <sub>CC</sub>  | 40                    | _                                | _                     | V    | $I_Q = 100 \mu A$ , $V_{IN} = V_{CC}$   |  |
| Supply Breakdown Voltage   | PACC  | 40                    | 1                                | 1                     | ٧    | $I_Q = 100 \mu A$ , $V_{IN} = V_{EE} = 0 V$   |  |
| Quiescent Supply Current   | 1-  | _                     | 1                                | 50                    | nA   | V <sub>CC</sub> = 30V, V <sub>IN</sub> = V <sub>CC</sub>  |  |
| Quiescent Supply Current   | ΙQ  | _                     | 1                                | 50                    | П    | $V_{CC} = 30V$ , $V_{IN} = V_{EE} = 0V$   |  |
| Peak Pulsed Source Current   | I <sub>(source)M</sub>  | _                     | 4.0                              | _                     | Α    | $V_{CC} = 5V$ , $I_{IN} = 1mA$ , $V_{OUT} = 0V$   |  |
| Peak Pulsed Sink Current   | I <sub>(sink)M</sub>  | _                     | 3.8                              |                       | ζ    | $V_{CC} = 5V$ , $I_{IN} = -1mA$ , $V_{OUT} = 5V$  |  |
| Source Current<br>with Varying Input Resistances                     | Isource   | _                     | 6.4<br>5.5<br>3.9<br>2.2<br>0.44 | 1                     | А    | $\begin{split} R_{IN} &= 200\Omega \\ R_{IN} &= 1k\Omega \\ R_{IN} &= 10k\Omega \\ R_{IN} &= 100k\Omega \\ R_{IN} &= 1000k\Omega \end{split} \qquad \begin{aligned} &V_{CC} &= 15V,  V_{EE} = 0V \\ &V_{IN} &= 15V \\ &C_{L} &= 1000F,  R_{L} = 0.18\Omega \end{aligned}$ |  |
| Sink Current<br>with Varying Input Resistances                       | Isink   | _                     | 7.7<br>6.5<br>4.4<br>2.3<br>0.46 |                       | А    | $\begin{split} R_{IN} &= 200\Omega \\ R_{IN} &= 1k\Omega \\ R_{IN} &= 10k\Omega \\ R_{IN} &= 100k\Omega \\ R_{IN} &= 1000k\Omega \\ \end{split}  \begin{array}{l} V_{CC} &= 15V,  V_{EE} = 0V \\ V_{IN} &= 15V \\ C_{L} &= 1000 F,  R_{L} = 0.18\Omega \\ \end{array}$    |  |
| Switching Times with Low Load Capacitance $C_L = 10nF$               | $t_{\text{d(rise)}} \\ t_{\text{r}} \\ t_{\text{d(fall)}} \\ t_{\text{f}}$                              | _                     | 8<br>48<br>16<br>35              |                       | ns   | $V_{CC} = 15V, V_{EE} = 0V$ $V_{IN} = 0 \text{ to } 15V$ $R_{IN} = 1k\Omega$ $C_{L} = 10nF, R_{L} = 0.18\Omega$   |  |
| Switching Times<br>with High Load Capacitance C <sub>L</sub> = 100nF | $\begin{array}{c} t_{\text{d(rise)}} \\ t_{\text{r}} \\ t_{\text{d(fall)}} \\ t_{\text{f}} \end{array}$ | _                     | 46<br>419<br>47<br>467           |                       | ns   | $\begin{split} &V_{CC}=15V,V_{EE}=0V\\ &V_{IN}=0\text{ to }15V\\ &R_{IN}=1k\Omega\\ &C_L=100nF,R_L=0.18\Omega \end{split}$  |  |
| Switching Times<br>with Asymmetric Source and Sink<br>Resistors      | t <sub>d(rise)</sub> t <sub>r</sub> t <sub>d(fall)</sub>  | _                     | 27<br>208<br>11<br>53            | П                     | ns   | $\begin{split} &V_{CC}=20\text{V},V_{EE}=\text{-}18\text{V}\\ &V_{IN}=\text{-}18\text{V to }20\text{V}\\ &R_{IN}=1k\Omega\\ &C_L=10\text{nF},R_L=0.18\Omega\\ &R_{SOURCE}=4.7\Omega,R_{SINK}=0\Omega \text{ (See page 7)}. \end{split}$                                   |  |

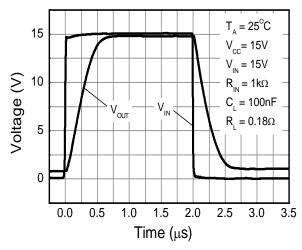
# **Switching Test Circuit and Timing Diagram**





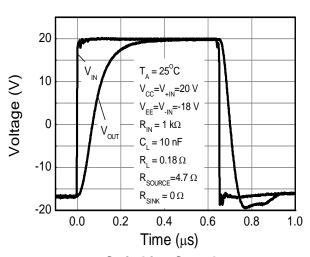
# Typical Switching Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

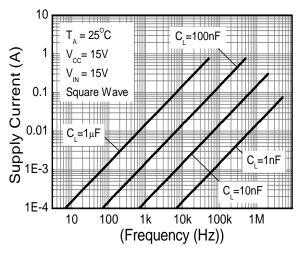




## **Switching Speed**

**Switching Speed** 



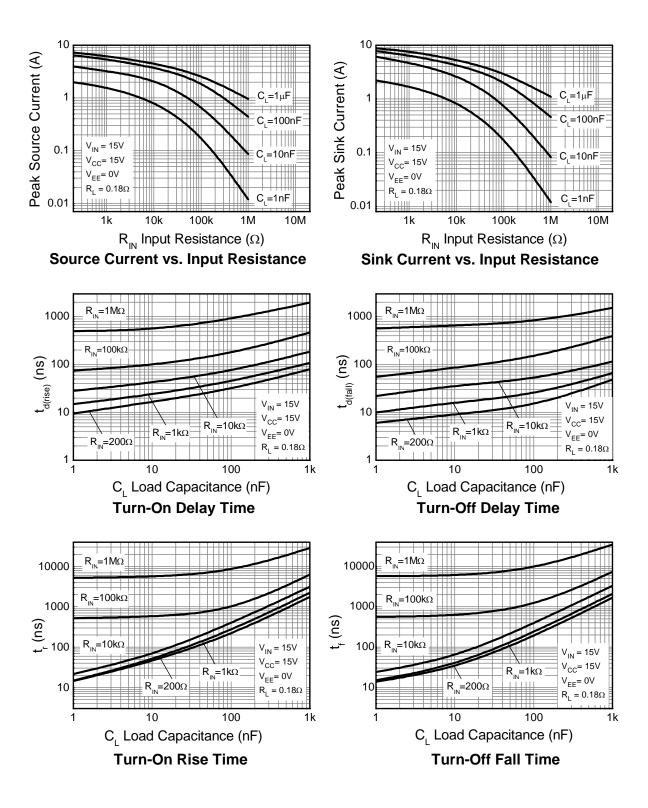


Switching Speed
Asymmetric Source and Sink Resistance

**Supply Current** 



## Typical Switching Characteristics (@TA = +25°C, unless otherwise specified.)

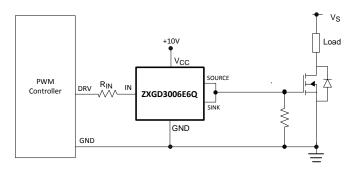




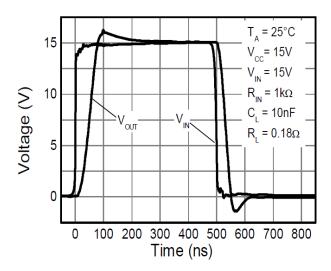
## **Circuit Examples**

## ZXGD3006E6Q Driving a MOSFET

Application example of the ZXGD3006E6Q driving the gate of a MOSFET from 0 to +15V.



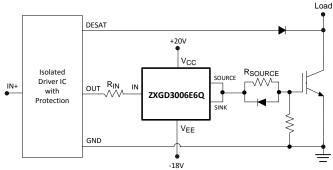
**Switching Time Characteristic** 



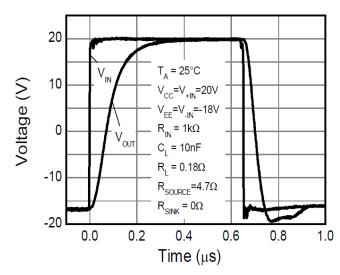
Symmetric Source and Sink Resistors

## ZXGD3006E6Q Driving an IGBT

Application example of ZXGD3006E6Q driving the gate of an IGBT with independent  $t_{ON}$  and  $t_{OFF}$  using asymmetric  $R_{SOURCE}$  and  $R_{SINK}$ . In addition, the gate is driven negative to -18V to prevent dV/dt induced false triggering.



**Switching Time Characteristic** 



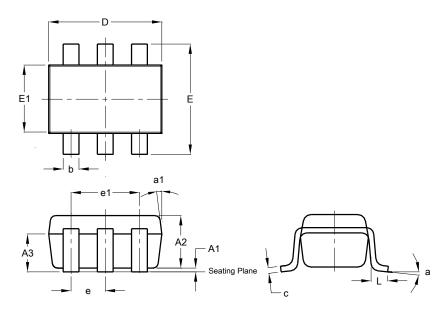
Asymmetric Source and Sink Resistors



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT26

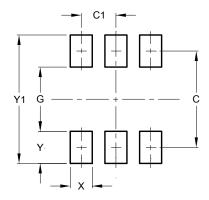


| SOT26                |       |      |      |  |  |  |  |
|----------------------|-------|------|------|--|--|--|--|
| Dim                  | Min   | Max  | Тур  |  |  |  |  |
| A1                   | 0.013 | 0.10 | 0.05 |  |  |  |  |
| A2                   | 1.00  | 1.30 | 1.10 |  |  |  |  |
| А3                   | 0.70  | 0.80 | 0.75 |  |  |  |  |
| b                    | 0.35  | 0.50 | 0.38 |  |  |  |  |
| С                    | 0.10  | 0.20 | 0.15 |  |  |  |  |
| D                    | 2.90  | 3.10 | 3.00 |  |  |  |  |
| е                    | -     | -    | 0.95 |  |  |  |  |
| e1                   | -     | -    | 1.90 |  |  |  |  |
| Е                    | 2.70  | 3.00 | 2.80 |  |  |  |  |
| E1                   | 1.50  | 1.70 | 1.60 |  |  |  |  |
| L                    | 0.35  | 0.55 | 0.40 |  |  |  |  |
| а                    | -     | -    | 8°   |  |  |  |  |
| a1                   | -     | -    | 7°   |  |  |  |  |
| All Dimensions in mm |       |      |      |  |  |  |  |

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT26



| Dimensions | Value (in mm) |
|------------|---------------|
| С          | 2.40          |
| C1         | 0.95          |
| G          | 1.60          |
| X          | 0.55          |
| Y          | 0.80          |
| Y1         | 3.20          |



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